

# Out-of-plane THz electric field enhancement in vertical nano-slit arrays

Y. Waeber<sup>2</sup>, S. Bagiante<sup>1,2</sup>, J. Fabiańska<sup>2</sup>, H. Sigg<sup>1</sup>, T. Feuerer<sup>2</sup>

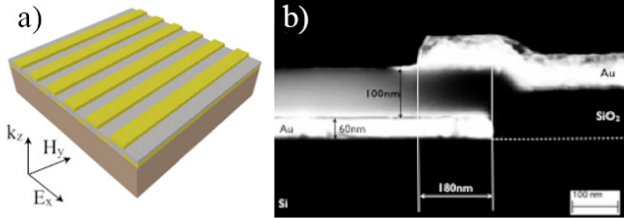
<sup>1</sup>Paul Scherrer Institute, 5232 Villigen, Switzerland

<sup>2</sup>University of Bern, 3012 Bern, Switzerland

**Abstract** — We report an out-of-plane electric field enhancement in the terahertz range, using a non-conventional planar nano-slit array. Both simulations and experiments demonstrate that the field enhancement and the transmission coefficient are comparable with those observed in a planar slit array. This novel geometry is realized using standard thin film technology and thus will open the way for many new experiments where strong out of plane THz fields are needed. The planar process allows fabrication of slits with sub-nanometer gap size.

## I. INTRODUCTION

Over the past decades our ability to fabricate and manipulate structures on the nanoscale has continuously grown and has resulted in numerous advances in nanoscience and nano-optics. For example, in 1998 Ebbesen et al. [1] demonstrated that nanoscale metallic antennas can couple incident optical beams to length scales much smaller than the diffraction limit. This scheme has recently been extended to the THz regime. Using suitable structures that act as nano-antennas, the electric field generated by THz light can be enhanced and localized to length scales well beyond the diffraction limit.

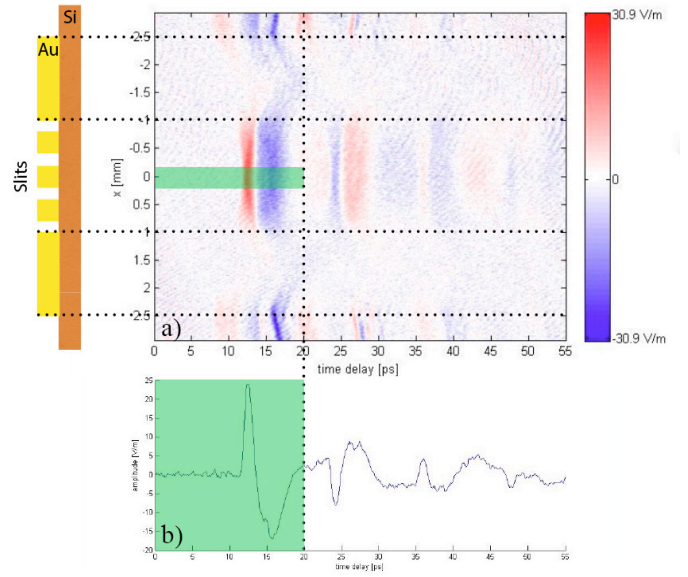


**Fig. 1.** a) Schematic illustration of the vertical nano-slit array. The slits are patterned with a periodicity of  $40 \mu\text{m}$  over an area of  $2 \times 2 \text{ mm}^2$ . b) Cross-section image of the vertical nano-slit array with a  $100 \text{ nm}$  high gap, obtained by scanning electron microscopy (SEM).

Due to the geometry of almost all structures, the electric field component, which is enhanced, is the in-plane component; see for example reference [2]. Here, we demonstrate the first out-of-plane field enhancement by using multilayer vertical nano-slit arrays. Through simulations and experiments we demonstrate that the field enhancement and the transmission coefficient are comparable to those observed in planar slit arrays. The corresponding structures are fabricated using standard thin film technology and will pave the way for experiments where strong out-of-plane THz electric fields are required. Our planar multilayer fabrication process is easy to implement, and allows fabrication of slits with sub-nanometer gap size.

## II. RESULTS

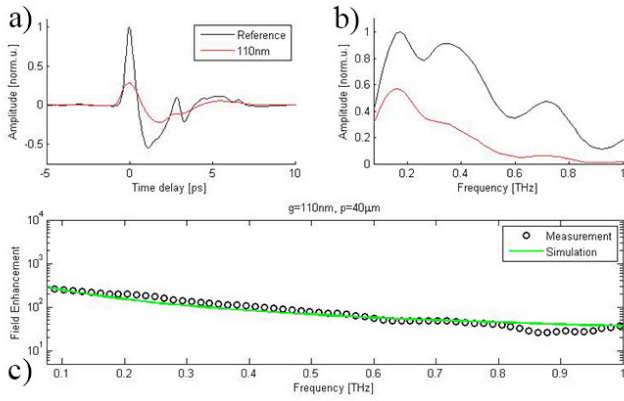
In a planar slit array, for a fixed slit length and gap width, the field enhancement volume can be increased only by increasing the gold layer thickness. Conversely, when using a vertical slit array (Fig. 1a), the active volume can be increased by overlapping the two Au layers along the x-direction. In our structure the overlap is  $180 \text{ nm}$ , approximately 3 times the Au layer thickness, as shown in Fig. 1b).



**Fig. 2.** a) THz pulse transmitted through a  $2 \text{ mm}$  wide vertical nano-slit array with a gap of  $g=11 \text{ nm}$  and a periodicity of  $p=40 \mu\text{m}$ . The vertical slits are surrounded by a solid gold frame ( $5 \times 5 \text{ mm}^2$ ) to guarantee the transmission of the pulse through the slits. Additionally, the pulses travelling around this gold frame are also plotted. The green box in a) shows the part of the measurement used for further calculations. Averaging the signal over  $x$  leads to the TD pulse pictured in b). Since there are several reflections present, the pulse is also cut after  $20 \text{ ps}$ .

Figure 2a) shows an actual measurement of a vertical slit sample with  $g=11 \text{ nm}$ ,  $p=40 \mu\text{m}$ . A solid gold frame surrounds the  $2 \times 2 \text{ mm}^2$ -area of vertical slits, leading to a clearly recognizable signal and thus confirming a transmission through the slits. Additionally, the incoming pulse travelling around the gold frame is also visible at the edges. For further calculations, the middle part of the signal is averaged, leading to the time-domain signal shown in Figure 2b). Further, the pulses are cut after  $20 \text{ ps}$  to suppress any reflections.

Figure 3a) shows the time-dependent THz signal after passing through the array of vertical nano-slits with a gap height of  $110 \text{ nm}$  (red curve) and the substrate only (i.e. substrate with a gold frame) for reference (black curve). The



**Fig. 3.** THz fields transmitted through a 110nm vertical nano-slit array (red curves) and a reference sample (black curves) in time a) and in frequency domain b). c) Field enhancement derived from b) (green circles) and corresponding simulation (blue curve).

field enhancement is obtained from  $FE(\omega) = (p/g) E_{sample}(\omega) / E_{reference}(\omega)$ , where  $p$  is the periodicity of the array, and  $g$  is the gap height.

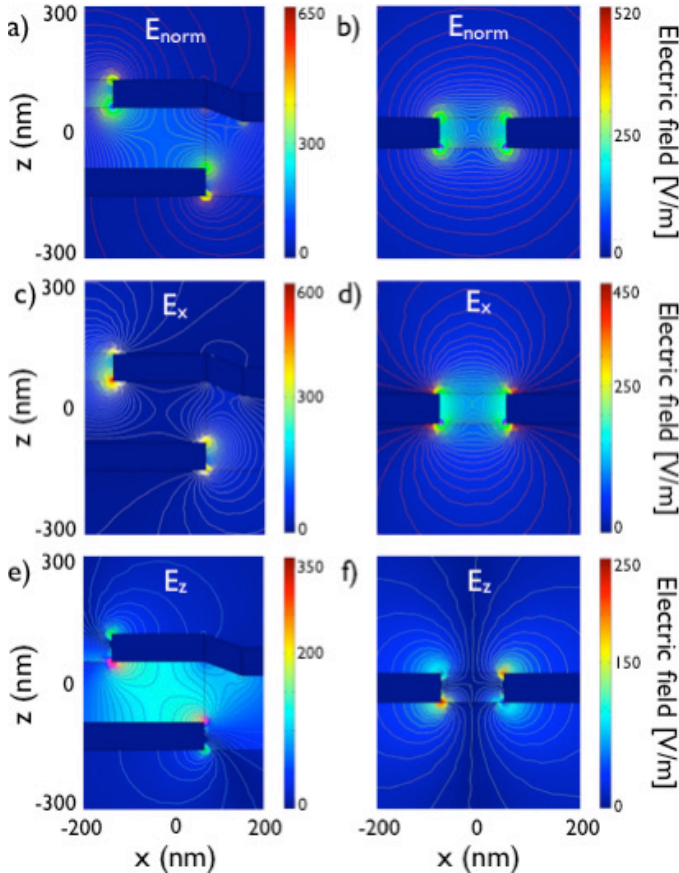
Figure 3c) shows the measured together with the simulated field enhancement. The simulations are performed in two dimensions with a commercial software (COMSOL) based on the finite element method (FEM).

### III. SUMMARY

We have demonstrated the possibility to rotate and to strongly enhance the incident THz field inside a vertically stacked nano-slit arrangement. Field enhancements as high as 300 were measured between 0.1 and 1 THz for 100 nm gaps.

### REFERENCES

- [1]. T. Ebbesen, H. Lezec, H. Ghaemi, T. Thio and P. Wolff, "Extraordinary optical transmission through sub-wavelength hole arrays," *Nature*, 391, 667669, 1998.
- [2]. M. Seo, H. Park, et. al., "Terahertz field enhancement by a metallic nano slit operating beyond the skin-depth limit," *Nature Photonics*, 3, 152156, 2009.



**Fig. 4.** Comparison between the vertical (left) and a planar nano-slit array (right); (a)-(b) Distribution of the normalized absolute electric field amplitude in an  $xz$ -slice cutting through the slit. (c)-(d) Electric field component along  $x$ -axis; (e)-(f) Electric field component along  $z$ -axis.